

SN54GTL16612, SN74GTL16612 18-BIT GTL/LVT UNIVERSAL BUS TRANSCEIVERS

SCBS480F – JUNE 1994 – REVISED JUNE 1997

- **Members of the Texas Instruments Widebus™ Family**
- **Translate Between GTL Logic Levels and LVTTTL or 5-V TTL Logic Levels**
- **Support Mixed-Mode Signal Operation on A Port**
- **Universal Bus Transceiver (UBT™) Combines D-Type Latches and D-Type Flip-Flops With Qualified Storage Enable**
- **Bus-Hold Data Inputs Eliminate the Need for External Pullup Resistors on A Port**
- **Flow-Through Architecture Facilitates Printed Circuit Board Layout**
- **Latch-Up Performance Exceeds 500 mA Per JESD 17**
- **Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Ceramic Flat (WD) Packages**

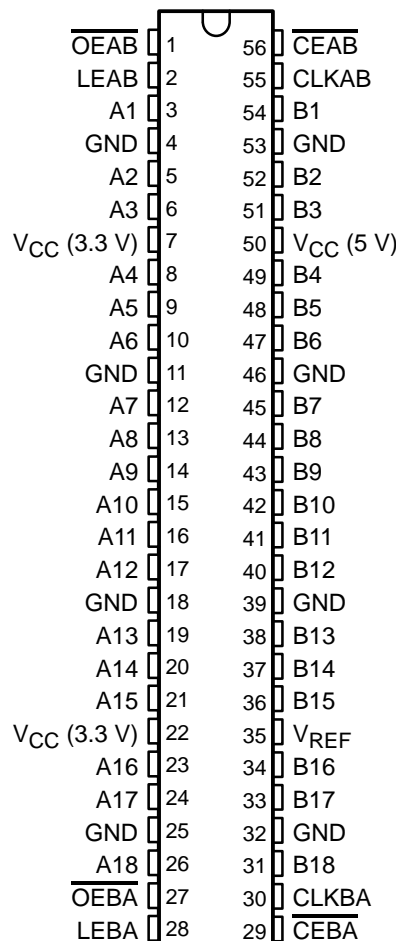
description

These 18-bit bus transceivers combine D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

The B port operates at GTL levels while the A port and control inputs are compatible with LVTTTL and 5-V TTL logic levels.

Data flow in each direction is controlled by output-enable (\overline{OEAB} and \overline{OEBA}), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock or latch-enable can be controlled by the clock-enable (\overline{CEAB} and \overline{CEBA}) inputs. For A-to-B data flow, the devices operate in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if \overline{CEAB} is low and CLKAB is held at a high or low logic level. If LEAB is low, the A-bus data is stored in the latch/flip-flop on the low-to-high transition of CLKAB if \overline{CEAB} is also low. \overline{OEAB} is active low. When \overline{OEAB} is low, the outputs are active. When \overline{OEAB} is high, the outputs are in the high-impedance state. Data flow for B to A is similar to that for A to B, but uses \overline{OEBA} , LEBA, CLKBA, and \overline{CEBA} .

SN54GTL16612 . . . WD PACKAGE
SN74GTL16612 . . . DGG OR DL PACKAGE
(TOP VIEW)



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description (continued)

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54GTL16612 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74GTL16612 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE†

INPUTS					OUTPUT B	MODE
\overline{CEAB}	\overline{OEAB}	LEAB	CLKAB	A		
X	H	X	X	X	Z	Latched storage of A data
L	L	L	H	X	B_0^{\ddagger}	
L	L	L	L	X	B_0^{\S}	
X	L	H	X	L	L	Transparent
X	L	H	X	H	H	
L	L	L	\uparrow	L	L	Clocked storage of A data
L	L	L	\uparrow	H	H	
H	L	L	X	X	B_0^{\S}	Clock inhibit

† A-to-B data flow is shown: B-to-A data flow is similar but uses \overline{OEBA} , LEBA, CLKBA, and \overline{CEBA} .

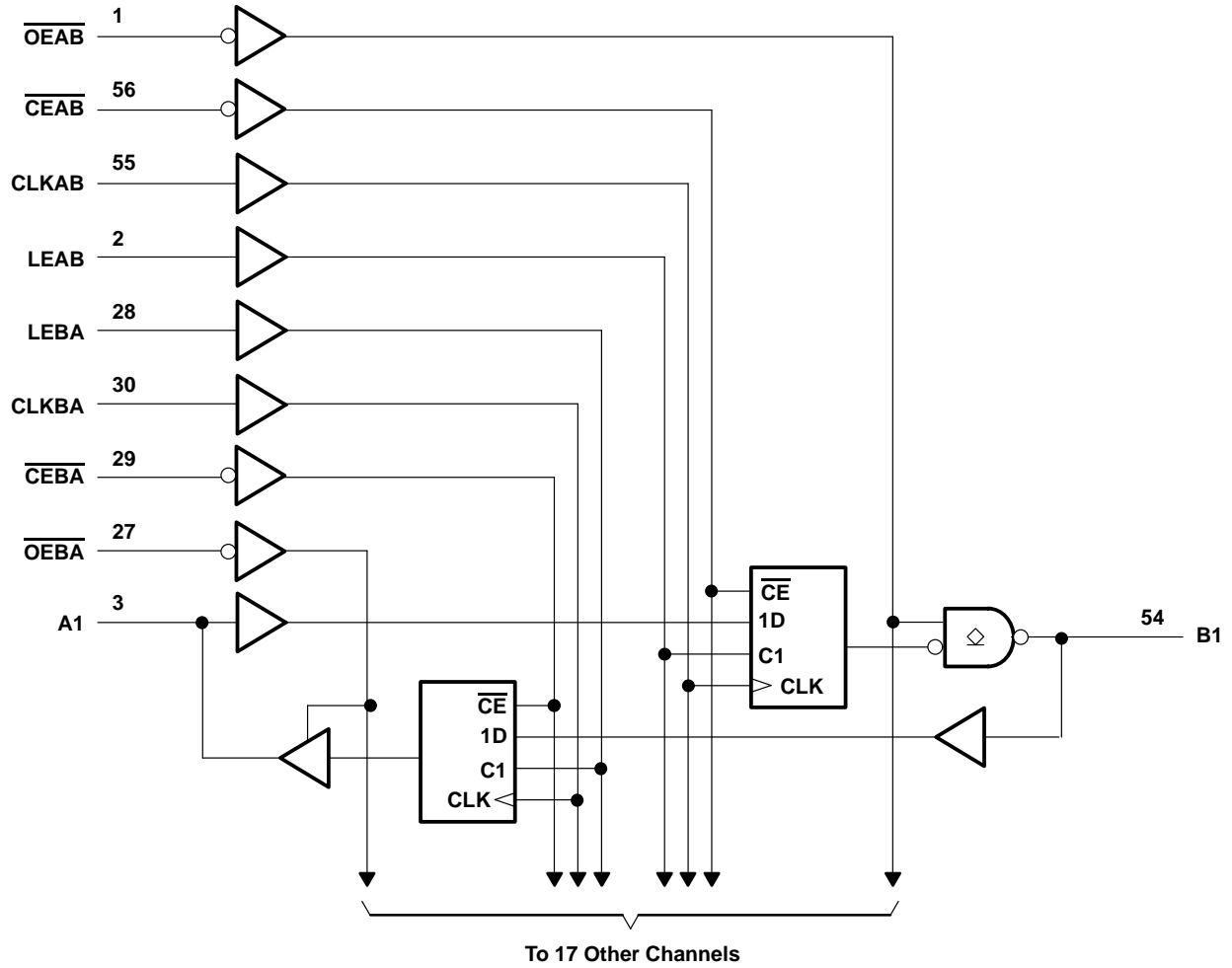
‡ Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low

§ Output level before the indicated steady-state input conditions were established

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} : 3.3 V	–0.5 V to 4.6 V
5 V	–0.5 V to 7 V
Input voltage range, V_I (see Note 1): A port	–0.5 V to 7 V
B port	–0.5 V to 4.6 V
Voltage range applied to any output in the high or power-off state, V_O (see Note 1): A port	–0.5 V to 7 V
B port	–0.5 V to 4.6 V
Current into any output in the low state, I_O : A port	128 mA
B port	80 mA
Current into any A-port output in the high state, I_O (see Note 2)	64 mA
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Package thermal impedance, θ_{JA} (see Note 3): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This current flows only when the output is in the high state and $V_O > V_{CC}$.
3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

			SN54GTL16612			SN74GTL16612			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	3.3 V	3.15	3.3	3.45	3.15	3.3	3.45	V
		5 V	4.75	5	5.25	4.75	5	5.25	
V _{REF}	Supply voltage		0.8			0.8			V
V _I	Input voltage	B port	V _{CC} (3.3 V)			V _{CC} (3.3 V)			V
		Except B port	5.5			5.5			
V _{IH}	High-level input voltage	B port	V _{REF} +50 mV			V _{REF} +50 mV			V
		Except B port	2			2			
V _{IL}	Low-level input voltage	B port	V _{REF} −50 mV			V _{REF} −50 mV			V
		Except B port	0.8			0.8			
I _{IK}	Input clamp current		−18			−18			mA
I _{OH}	High-level output current	A port	−32			−32			mA
I _{OL}	Low-level output current	A port	64			64			mA
		B port	40			40			
T _A	Operating free-air temperature		−55			−40			°C
			125			85			

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range, $V_{REF} = 0.8\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54GTL16612			SN74GTL16612			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}		$V_{CC} (3.3\text{ V}) = 3.15\text{ V}$, $V_{CC} (5\text{ V}) = 4.75\text{ V}$	$I_I = -18\text{ mA}$			-1.2			-1.2	V
V_{OH}	A port	$V_{CC} = \text{MIN to MAX}^\ddagger$, $V_{CC} (3.3\text{ V}) = 3.15\text{ V}$, $V_{CC} (5\text{ V}) = 4.75\text{ V}$	$I_{OH} = -100\text{ }\mu\text{A}$	$V_{CC}-0.2$			$V_{CC}-0.2$			V
			$I_{OH} = -8\text{ mA}$	2.4			2.4			
			$I_{OH} = -32\text{ mA}$	2			2			
V_{OL}	A port	$V_{CC} (3.3\text{ V}) = 3.15\text{ V}$, $V_{CC} (5\text{ V}) = 4.75\text{ V}$	$I_{OL} = 100\text{ }\mu\text{A}$			0.2			0.2	V
			$I_{OL} = 16\text{ mA}$			0.4			0.4	
			$I_{OL} = 32\text{ mA}$			0.5			0.5	
			$I_{OL} = 64\text{ mA}$			0.6			0.55	
	B port	$V_{CC} (3.3\text{ V}) = 3.15\text{ V}$, $V_{CC} (5\text{ V}) = 4.75\text{ V}$, $I_{OL} = 40\text{ mA}$				0.5			0.4	
I_I	Control inputs	$V_{CC} = 0\text{ or MAX}^\ddagger$, $V_I = 5.5\text{ V}$				10			10	μA
	A port	$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$	$V_I = 5.5\text{ V}$			1000			20	
			$V_I = V_{CC}$			1			1	
			$V_I = 0$			-30			-30	
	B port	$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$	$V_I = V_{CC} (3.3\text{ V})$			5			5	
			$V_I = 0$			-5			-5	
I_{off}		$V_{CC} = 0$, V_I or $V_O = 0$ to 4.5 V				1000			100	μA
$I_I(\text{hold})$	A port	$V_{CC} (3.3\text{ V}) = 3.15\text{ V}$, $V_{CC} (5\text{ V}) = 4.75\text{ V}$	$V_I = 0.8\text{ V}$			75			75	μA
			$V_I = 2\text{ V}$			-75			-75	
I_{OZH}	A port	$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$, $V_O = 3\text{ V}$				1			1	μA
	B port	$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$, $V_O = 1.2\text{ V}$				10			10	
I_{OZL}	A port	$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$, $V_O = 0.5\text{ V}$				-1			-1	μA
	B port	$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$, $V_O = 0.4\text{ V}$				-10			-10	
$I_{CC} (3.3\text{ V})$	A or B port	$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$, $I_O = 0$, $V_I = V_{CC} (3.3\text{ V})$ or GND	Outputs high			1			1	mA
			Outputs low			5			5	
			Outputs disabled			1			1	
$I_{CC} (5\text{ V})$	A or B port	$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$, $I_O = 0$, $V_I = V_{CC} (3.3\text{ V})$ or GND	Outputs high			120			120	mA
			Outputs low			120			120	
			Outputs disabled			120			120	
ΔI_{CC}^\S		$V_{CC} (3.3\text{ V}) = 3.45\text{ V}$, $V_{CC} (5\text{ V}) = 5.25\text{ V}$, A or control inputs at $V_{CC} (3.3\text{ V})$ or GND, One input at 2.7 V				1			1	mA
C_i	Control inputs	$V_I = 3.15\text{ V}$ or 0				3.5	12		3.5	pF
C_{io}	A port	$V_O = 3.15\text{ V}$ or 0				12	18		12	pF
	B port	Per IEEE Std 1194.1				10			5	

† All typical values are at $V_{CC} (3.3\text{ V}) = 3.3\text{ V}$, $V_{CC} (5\text{ V}) = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



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timing requirements over recommended ranges of supply voltage and operating free-air temperature, $V_{REF} = 0.8\text{ V}$ (unless otherwise noted)

			SN54GTL16612		SN74GTL16612		UNIT
			MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency		0	95	0	95	MHz
t_w	Pulse duration	LEAB or LEBA high	3.3		3.3		ns
		CLKAB or CLKBA high or low	5.6		5.6		
t_{su}	Setup time	A before CLKAB \uparrow	1.2		0		ns
		B before CLKBA \uparrow	3.4		2.5		
		A before LEAB \downarrow	1.2		0.4		
		B before LEBA \downarrow	1		0.9		
		\overline{CEAB} before CLKAB \uparrow	2.1		1		
		\overline{CEBA} before CLKBA \uparrow	2.6		2.1		
t_h	Hold time	A after CLKAB \uparrow	2.9		2.7		ns
		B after CLKBA \uparrow	4.1		0.4		
		A after LEAB \downarrow	4.5		3.4		
		B after LEBA \downarrow	4.3		3.3		
		\overline{CEAB} after CLKAB \uparrow	2		1.5		
		\overline{CEBA} after CLKBA \uparrow	1		0.4		

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $V_{REF} = 0.8\text{ V}$ (see Figure 1)

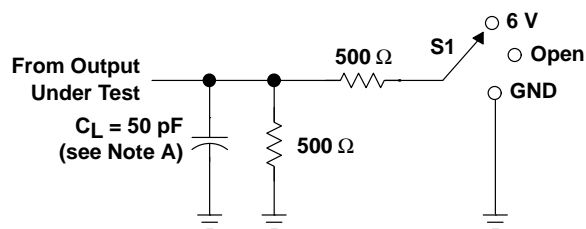
PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54GTL16612			SN74GTL16612			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
f _{max}			95			95			MHz
t _{PLH}	A	B	1	2.6	4.5	1	2.6	3.8	ns
t _{PHL}			1	2.2	4.5	1	2.2	4	
t _{PLH}	LEAB	B	1	3.6	5.5	1.8	3.6	5.4	ns
t _{PHL}			1	3.3	6	1.5	3.3	5.5	
t _{PLH}	CLKAB	B	1	3.7	5.5	1.8	3.7	5.3	ns
t _{PHL}			1	3.3	5.5	1.5	3.3	5.5	
t _{PLH}	\overline{OEAB}	B	1	3.3	5.5	1.6	3.3	4.7	ns
t _{PHL}			1	3.2	5.5	1.3	3.2	5.5	
t _r	Transition time, B outputs (0.5 V to 1 V)		1.3			1.3			ns
t _f	Transition time, B outputs (1 V to 0.5 V)		0.5			0.5			ns
t _{PLH}	B	A	2	4.8	6.9	2	4.8	6.9	ns
t _{PHL}			1	3.6	5.1	1.4	3.6	5.1	
t _{PLH}	LEBA	A	2	4.3	6.1	2.1	4.3	6.1	ns
t _{PHL}			1	3.6	5.1	1.9	3.6	5.1	
t _{PLH}	CLKBA	A	2	4.5	6.4	2.3	4.5	6.4	ns
t _{PHL}			2	4	5.6	2.2	4	5.6	
t _{en}	\overline{OEBA}	A	1	4.7	7.5	1.9	4.7	7.2	ns
t _{djs}			2	4.6	6.9	2.5	4.6	6.9	

\dagger All typical values are at V_{CC} (3.3 V) = 3.3 V, V_{CC} (5 V) = 5 V, $T_A = 25^\circ\text{C}$.



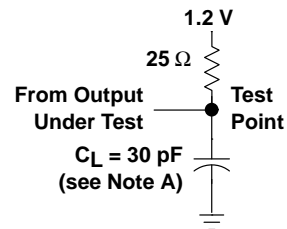
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PARAMETER MEASUREMENT INFORMATION

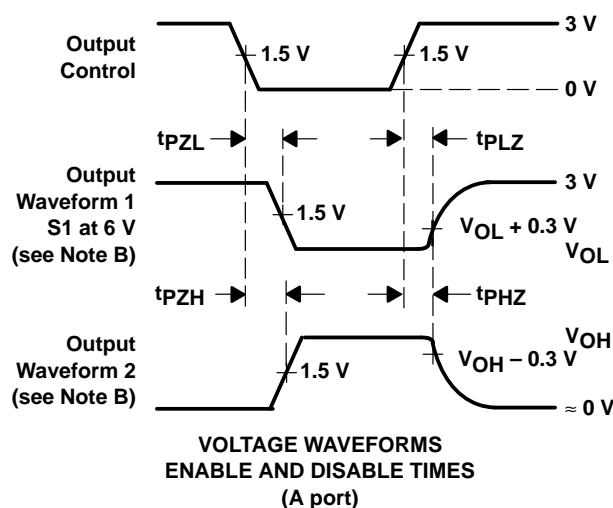
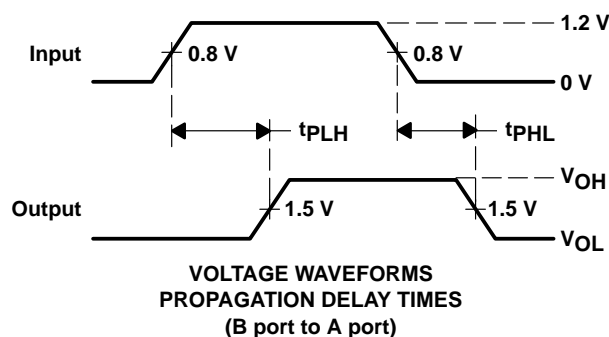
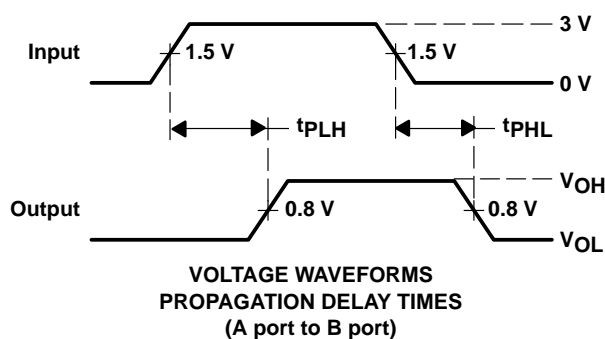
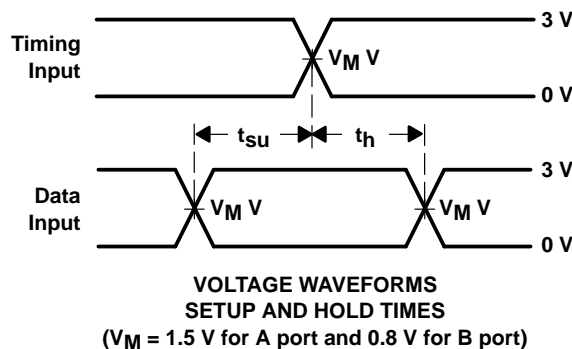
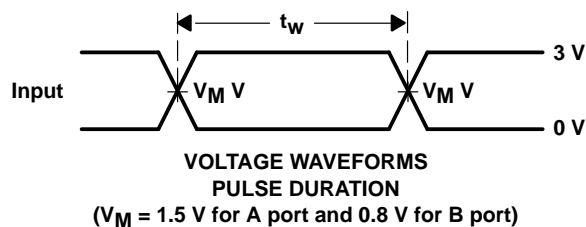


LOAD CIRCUIT FOR A OUTPUTS

TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND



LOAD CIRCUIT FOR B OUTPUTS



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.
 - D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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